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PATENT

JUN 01 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICEIn re application of: Wen-Chou Vincent Wang, *et al.* Attorney Docket No.: ALTRP100/A1198

Application No.: 10/719,218

Examiner: Shrinivas H. Rao

Filed: November 20, 2003

Group: 2814

Title: STRUCTURE, MATERIAL AND DESIGN
FOR ASSEMBLING A LOW-K Si DIE TO
ACHIEVE AN INDUSTRIAL GRADE
RELIABILITY WIRE BONDING PACKAGE

CERTIFICATE OF TRANSMISSION

I hereby certify that this correspondence is being transmitted via facsimile to the U.S. Patent and Trademark Office, Attention: Examiner
Shrinivas H. Rao at facsimile telephone number (571) 273-8300 on June 1, 2006.

Printed Name: Leslin Russell

Signed: **AMENDMENT B**

(Submitted with an RCE herewith)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Final Office Action mailed 8 March 2006 and the Advisory Action mailed 17 May 2006, the period of response which extends to June 8, 2006, please consider the following remarks and amend the above identified Application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.

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